

FFPF10UP30ST

Features

- Ultrafast Recovery t_{rr} = 45 ns (@ I_F = 10 A)
- Max Forward Voltage, V_F = 1.4 V (@ T_C = 25°C)
- Reverse Voltage, V_{RRM} = 300 V
- Avalanche Energy Rated
- RoHS Compliant

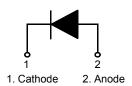
Applications

- General Purpose
- · Switching Mode Power Supply
- Free-Wheeling Diode for Motor Application
- · Power Switching Circuits

10 A, 300 V, Ultrafast Diode

The FFPF10UP30S is an ultrafast diode with low forward voltage drop and rugged UIS capability. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial applicationa as welder and UPS application.





Absolute Maximum Ratings (per diode) T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Unit
V_{RRM}	Peak Repetitive Reverse Voltage	300	V
V_{RWM}	Working Peak Reverse Voltage	300	V
V _R	DC Blocking Voltage	300	V
I _{F(AV)}	Average Rectified Forward Current @ T _C = 125°C	10	A
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	100	A
T _{J,} T _{STG}	Operating Junction and Storage Temperature	- 65 to +150	°C

Thermal Characteristics T_a = 25°C unless otherwise noted

Symbol	Parameter	Max	Unit
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	4.0	°C/W

Electrical Characteristics (per diode) T_a = 25°C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Unit
V _F *	I _F = 10 A I _F = 10 A	T _C = 25 °C T _C = 150 °C	-	-	1.4 1.2	V V
I _R *	V _R = 300 V V _R = 300 V	T _C = 25 °C T _C = 150 °C		-	100 500	μ Α μ Α
t _{rr}	I_F =1 A, di/dt = 100 A/ μ s, V _{CC} = 30 V I_F =10 A, di/dt = 200 A/ μ s, V _{CC} = 195 V	T _C = 25 °C T _C = 25 °C		-	35 45	ns ns
t _a t _b Q _{rr}	I _F =10 A, di/dt = 200 A/μs, V _{CC} = 195 V	$T_C = 25 ^{\circ}C$ $T_C = 25 ^{\circ}C$ $T_C = 25 ^{\circ}C$	- - -	11 13 20	- - -	ns ns nC
W _{AVL}	Avalanche Energy (L = 20 mH)		20	-	-	mJ

^{*}Pulse Test: Pulse Width=300 μ s, Duty Cycle=2%

Typical Performance Characteristics

Figure 1. Typical Forward Voltage Drop

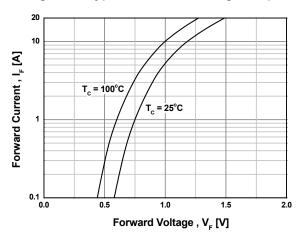


Figure 2. Typical Reverse Current

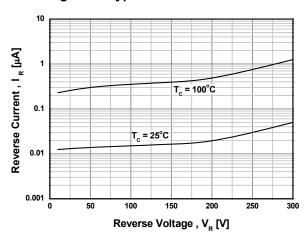


Figure 3. Typical Junction Capacitance

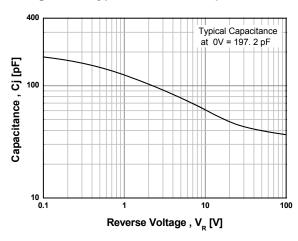


Figure 4. Typical Reverse Recovery Time

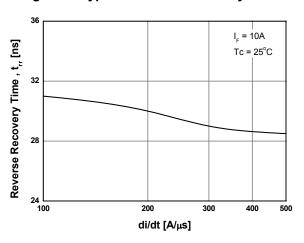


Figure 5. Typical Reverse Recovery Current

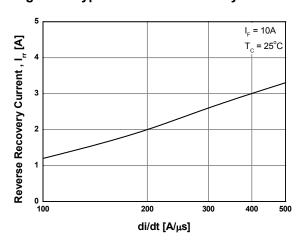
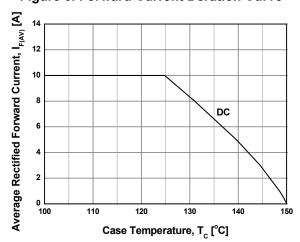
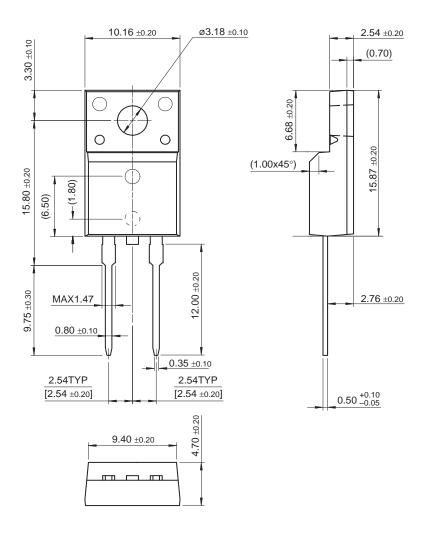


Figure 6. Forward Current Deration Curve



Package Demensions

TO-220F 2L



Dimensions in Millimeters





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

FPS™ 2Cool™ AccuPower™ F-PFS™ AX-CAP FRFET® Global Power Resource BitSiC™

Build it Now™ GreenBridge™ Green FPS™ CorePLUS™ CorePOWER™ Green FPS™ e-Series™

CROSSVOLT™ Gmax™ GTO™ CTL™ Current Transfer Logic™ IntelliMAX™ DEUXPEED[®] ISOPI ANAR™

Dual Cool™ Making Small Speakers Sound Louder

EcoSPARK® and Better™ EfficientMax™ MegaBuck⊺ MICROCOUPLER™ ESBC™ ®

MicroFET™

MicroPak™ MicroPak2™

Fairchild Semiconductor® MillerDrive™ FACT Quiet Series™ MotionMax™ mWSaver™ OptoHiT[™] OPTOLOGIC® OPTOPLANAR® PowerTrench®

PowerXS™ Programmable Active Droop™

OFET QSTN

Quiet Series™ RapidConfigure™

Saving our world, 1mW/W/kW at a time™ SignalWise™

SmartMax™ SMART START™

Solutions for Your Success™

SPM®

STEALTH™ SuperFET[®] SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS® SyncFET™

Svnc-Lock™ SYSTEM GENERAL®*

TinyBoost™ TinyBuck™ TinyCalc™ TinyLogic[©] TINYOPTO™

TinyPower™ TinyPWM™ TinyWire™ TranSiC™

TriFault Detect™ TRUECURRENT®* uSerDes™

UHC Ultra FRFET™ UniFET^T VCX™ VisualMax™ VoltagePlus™

XS™

DISCLAIMER

F

Fairchild[®]

FACT®

FastvCore™

FETBench™

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FARCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are 2. A critical component in any component of a life support, device, or intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user
- system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Definition of Terms				
Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

Rev. 164

^{*} Trademarks of System General Corporation, used under license by Fairchild Semiconductor.